

SUPER FAST GLASS PASSIVATED RECTIFIERS

Reverse Voltage – 800 V

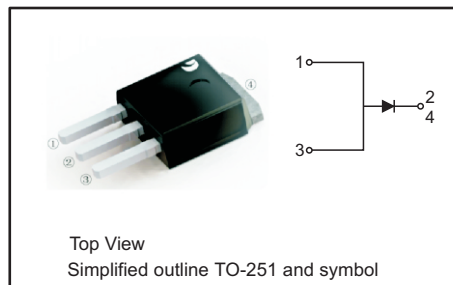
Forward Current – 10 A

FEATURES

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed

PINNING

PIN	DESCRIPTION
2,4	Cathode
1,3	Anode



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

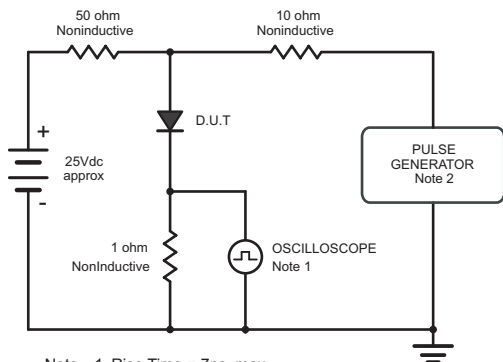
Parameter	Symbols	SF1008VYC	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	800	V
Maximum RMS voltage	V_{RMS}	560	V
Maximum DC Blocking Voltage	V_{DC}	800	V
Maximum Average Forward Rectified Current @ Fig.1	$I_{F(AV)}$	10	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	160	A
Peak Forward Surge Current, 1.0ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	320	A
I^2t Rating for fusing ($3ms \leq t \leq 8.3ms$)	I^2t	106.2	A ² S
Max Instantaneous Forward Voltage at 10 A	V_F	2.8	V
Maximum DC Reverse Current at Rated DC Reverse Voltage $T_a = 25^\circ C$ $T_a = 125^\circ C$	I_R	1 300	μA
Typical Junction Capacitance ⁽¹⁾	C_j	77	pF
Maximum Reverse Recovery Time ⁽²⁾	t_{rr}	35	ns
Typical Thermal Resistance (without heat sink)	$R_{\theta JA}$ $R_{\theta JC}$ $R_{\theta JL}$	55 6 10	$^\circ C/W$
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150	$^\circ C$

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Measured with $I_F = 0.5 A$, $I_R = 1 A$, $I_{rr} = 0.25 A$.



Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.

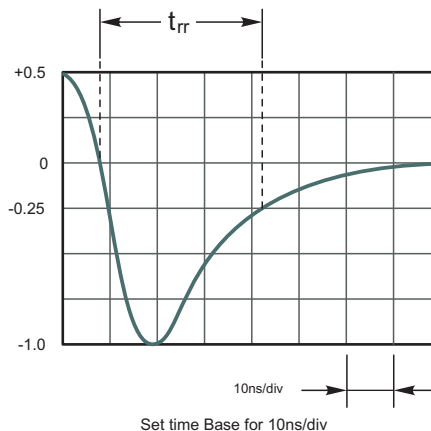


Fig.2 Maximum Average Forward Current Rating

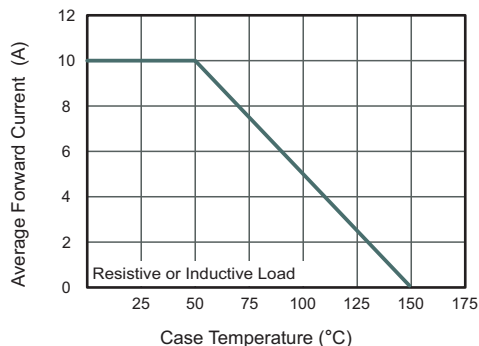


Fig.3 Typical Reverse Characteristics

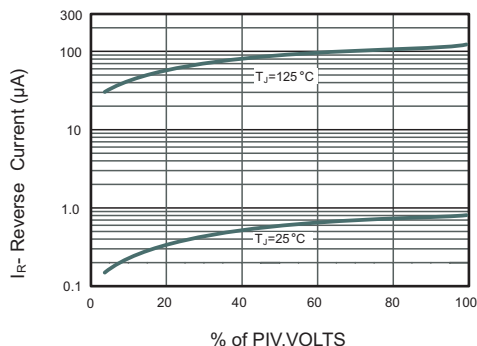


Fig.4 Typical Forward Characteristics

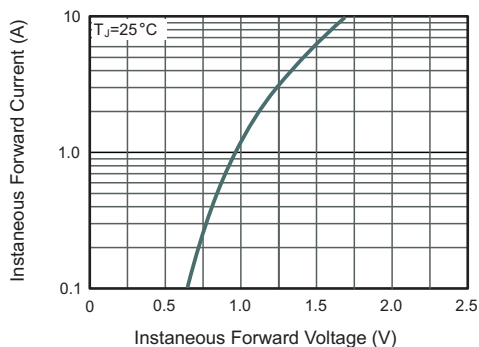


Fig.5 Typical Junction Capacitance

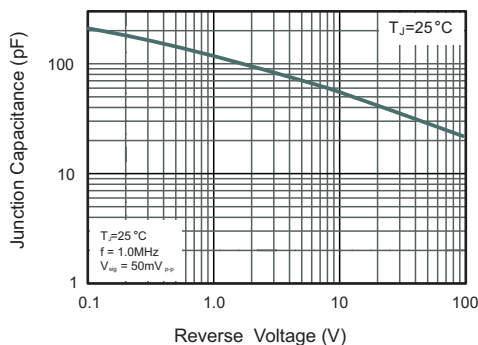
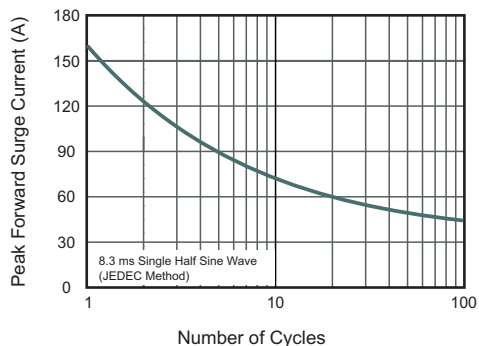


Fig.6 Maximum Non-Repetitive Peak Forward Surge Current

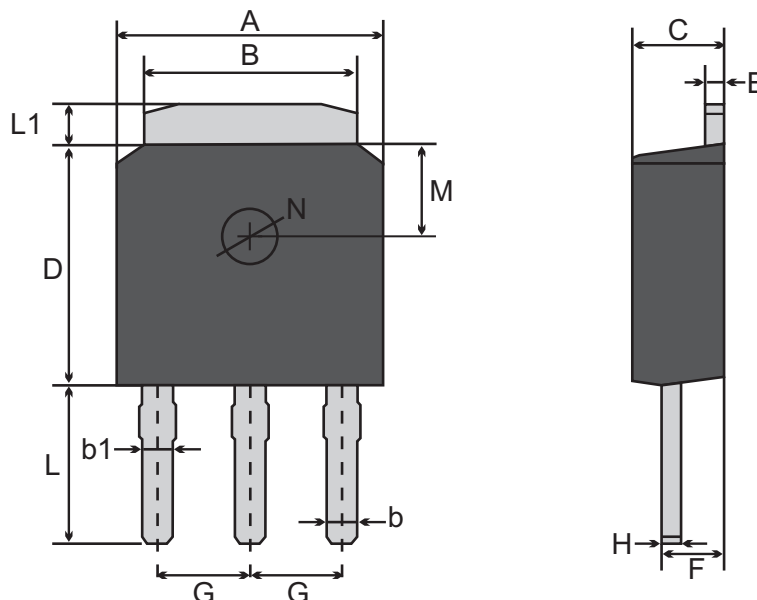




PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

TO-251



TO-251(I-PAK) mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	6.7	5.5	0.86	0.9	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	4.3	1.2	1.8 TYPICAL	1.3 TYPICAL
	min	6.3	5.1	0.66	0.76	2.1	5.9	0.4	1.3		0.45	3.9	0.8		
mil	max	264	217	33	35	98	248	24	71	90 TYPICAL	22	169	47	71 TYPICAL	51 TYPICAL
	min	248	201	26	30	83	232	16	51		18	154	31		

Marking

Type number	Marking code
SF1008VYC	SF1008VY



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